WNSC2D301200W



Silicon Carbide Diode

Rev.01 - 21 June 2022

Product data sheet

1. General description

WeEn Sem

Silicon Carbide Schottky diode in a TO247-2L plastic package, designed for high frequency switched-mode power supplies.



- Highly stable switching performance
- High forward surge capability IFSM
- Extremely fast reverse recovery time
- Superior in efficiency to Silicon Diode alternatives
- Reduced losses in associated MOSFET
- Reduced EMI
- Reduced cooling requirements
- RoHS compliant
- High junction operating temperature capability (T_{i(max)} = 175 °C)

3. Applications

- Power factor correction
- Telecom / Server SMPS
- UPS
- PV inverter
- PC Silverbox
- LED / OLED TV
- Motor Drives

4. Quick reference data

Table 1. Q	uick reference data						
Symbol	Parameter	Conditions	Notes	Values			Unit
Absolute	maximum rating						
V_{RRM}	repetitive peak reverse voltage				1200		V
I _{F(AV)}	average forward current	δ = 0.5 ; square-wave pulse; T _{mb} ≤ 114 °C; Fig. 1; Fig. 2; Fig. 3		30		A	
Tj	junction temperature			-55 to 175		°C	
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static ch	aracteristics		<u>`</u>				
V _F	forward voltage	I _F = 30 A; T _j = 25 °C; <u>Fig. 5</u>		-	1.42	1.60	V
		I _F = 30 A; T _j = 150 °C; <u>Fig. 5</u>		-	1.90	2.30	V
		I _F = 30 A; T _j = 175 °C; <u>Fig. 5</u>		-	2.00	2.50	V
Dynamic	characteristics						
Q _r	recovered charge	$I_F = 30 \text{ A}; \text{ d}I_F/\text{d}t = 500 \text{ A}/\mu\text{s}; V_R = 400 \text{ V};$ $T_j = 25 \text{ °C}; \text{ Fig. 7}$		-	68	-	nC



5. Pinning information

Table 2. P	inning infor	mation		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	К	cathode		
2	А	anode		K — A 001aaa020
mb	mb	mounting base; connected to cathode	ГЛ ГЛ Г ГЛ Г Г К А ТО247-2L	

6. Ordering information

Table 3. Ordering information							
Type number	Package name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date	
WNSC2D301200W	TO247-2L	WNSC2D301200W6Q	Tube	30	TO247L-2L	10-Nov-2020	

7. Marking

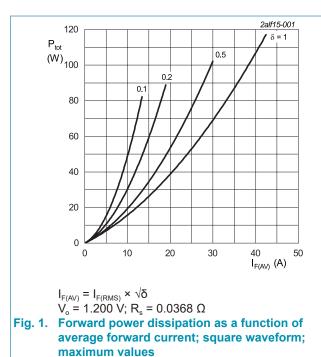
Table 4. Marking codes	
Type number	Marking codes
WNSC2D301200W	WNSC2D
	301200W

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Notes	Values	Unit
V _{RRM}	repetitive peak reverse voltage			1200	V
V _{RWM}	crest working reverse voltage			1200	V
V _R	reverse voltage	DC		1200	V
I _{F(AV)}	average forward current	δ = 0.5; square-wave pulse; T _{mb} 114 ≤ °C; Fig. 1; Fig. 2; Fig. 3		30	A
I _{FRM}	repetitive peak forward current	δ = 0.5; t _p = 25 µs; T _{mb} ≤ 114 °C; square-wave pulse		60	A
I _{FSM}	non-repetitive peak	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse		270	А
	forward current	t_p = 10 µs; $T_{j(init)}$ = 25 °C; square-wave pulse		1500	А
l ² t	I ² t for fusing	sine-wave pulse; T _{j(init)} = 25 °C; t _p = 10 ms		364.5	A ² s
T _{stg}	storage temperature			-55 to 175	°C
Tj	junction temperature			-55 to 175	°C



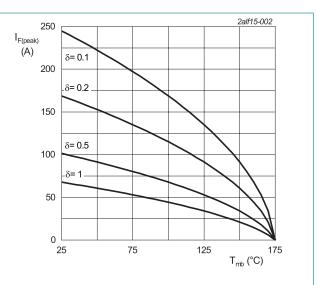
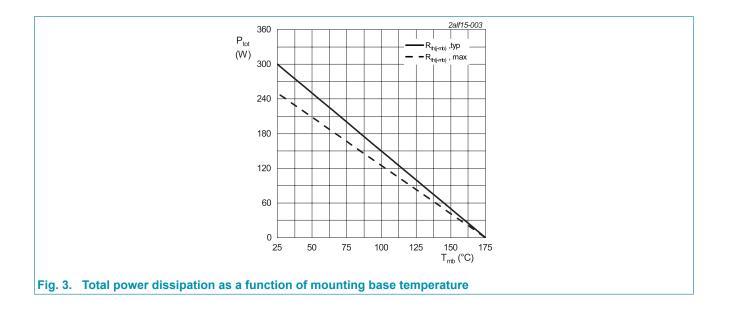


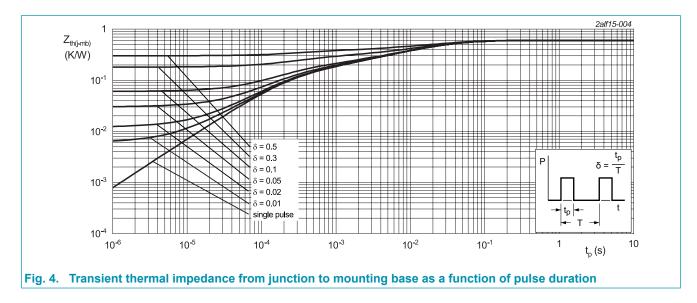
Fig. 2. Current derating as a function of mounting base temperature

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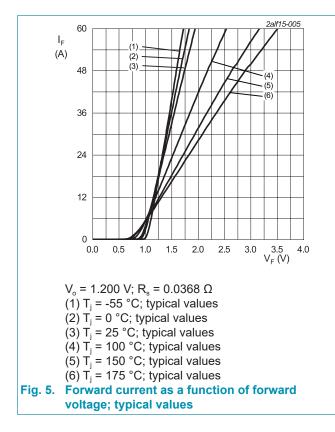
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
$R_{\text{th(j-mb)}}$	thermal resistance from junction to mounting base	<u>Fig. 4</u>		-	0.5	0.6	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	in free air		-	40	-	K/W

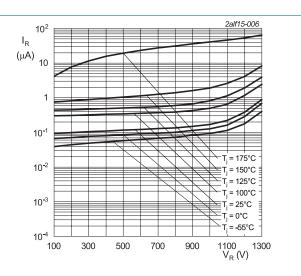
9. Thermal characteristics



10. Characteristics

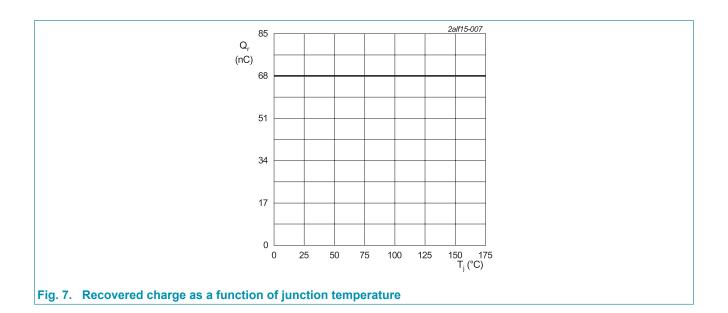
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static cha	racteristics						
V _F	forward current	I _F = 30 A; T _j = 25 °C; <u>Fig. 5</u>		-	1.42	1.60	V
		I _F = 30 A; T _j = 150 °C; <u>Fig. 5</u>		-	1.90	2.30	V
		I _F = 30 A; T _j = 175 °C; <u>Fig. 5</u>		-	2.00	2.50	V
I _R	reverse current	V _R = 1200 V; T _j = 25 °C; <u>Fig. 6</u>		-	1	150	μA
		V _R = 1200 V; T _j = 175 °C; <u>Fig. 6</u>		-	50	1500	μA
Dynamic	characteristics	·					
Q _r	recovered charge	$I_F = 30 \text{ A}; V_R = 400 \text{ V}; \text{ d}_F/\text{d}t = 500 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$		-	68	-	nC
C _d	diode capacitance	f = 1 MHz; V _R = 1 V; T _j = 25 °C		-	1407	-	pF
		f = 1 MHz; V _R = 400 V; T _j = 25 °C		-	125	-	pF
		f = 1 MHz; V _R = 800 V; T _j = 25 °C		-	93	-	pF
E _{as}	non-repetitive avalanche energy	I _R = 8 A; L = 10 mH; T _{j(init)} = 25 °C		300	-	-	mJ



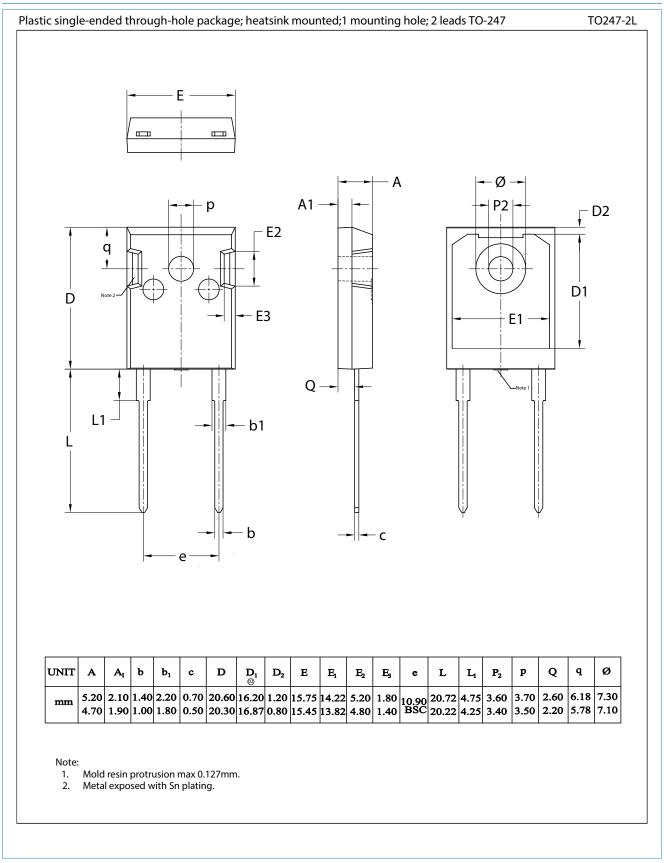




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11. Package outline



WNSC2D301200W

Silicon Carbide Diode

12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
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